

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In application of: RAMINDA U. MADURawe
Application No.:
Title: Semiconductor Latches and SRAM Devices
Filed: 01/22/2004

INFORMATION DISCLOSURE STATEMENT SUBMISSION

Sirs:

Attached is IDS form 1449 for the Application submitted herewith entitled "Semiconductor Latches and SRAM Devices", said application a division of Application Serial No 10/413,810 filed on Apr. 14, 2003, copies of said IDS references filed on Aug 05, 2003.

Regards,



Raminda U. Madurawe

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PTO/SB/08A (08-00)

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Sheet 1 of 1

Complete if Known

Application Number	
Filing Date	01/22/2004
First Named Inventor	Madurawe, Raminda U.
Group Art Unit	
Examiner Name	
Attorney Docket Number	

U.S. PATENT DOCUMENTS

Examiner Initials *	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number	Kind Code ² (if known)			
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Examiner Initials *	Cite No. ¹	Foreign Patent Document			Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶
		Office ³	Number ⁴	Kind Code ⁵ (if known)				
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